Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1230	(324/751,752,719,658).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 21:58
L2	2301	(438/7,10,16,17).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 21:58
L3	2829	(134/1,1.2,1.1).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 21:58
L4	903	(134/1.3).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF .	2005/12/07 21:59
L5	1431	(204/157.15,157.4,157.41,157.44). CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 21:59
L6	4076	(356/364,369,600,601,612, 445-448).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 21:59
L7	1070	(250/225).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 22:00
L8	472	(1 2 3 4 5 6 7) and (laser same (clean\$3 ablat\$3))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 22:00
L9	169	(1 2 3 4 5 6 7) and (laser near (clean\$3 ablat\$3))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 22:15
L10	1089	(1 2 3 4 5 6 7) and (surface near (clean\$3 ablat\$3))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 22:01
L11	1408	8 10	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 22:01
L12	68	11 and ((film layer) near (inspect\$3 measur\$4))	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/07 22:16
L13	4	("6355494").URPN.	USPAT	OR	OFF	2005/12/07 22:09
L14	8	("3755026" "5308161" "5413942" "5586099" "5790491" "5851488" "5963781" "6174741").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/07 22:10
L15	99860	(surface near (clean\$3 ablat\$3)) (laser near (clean\$3 ablat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/07 22:21

L16	1676	15 and ((film layer) near (inspect\$3 measur\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:17
L17	1593	(surface near (clean\$3 ablat\$3)) and (laser near (clean\$3 ablat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/07 22:16
L18	1676	16 and ((film layer) near (inspect\$3 measur\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:16
L19	71	17 and ((film layer) near (inspect\$3 measur\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:22
L20	71	19 not 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:17
L21	21302	((surface near (clean\$3 ablat\$3)) same (substrate wafer semiconduct\$3)) ((laser near (clean\$3 ablat\$3)) same (substrate wafer semiconduct\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/07 22:21
L22	24119	((surface near (clean\$3 ablat\$3)) same (substrate wafer semiconduct\$3)) ((laser near (clean\$3 ablat\$3)) same (substrate wafer semiconduct\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:23
L23	934	22 and ((film layer) near (inspect\$3 measur\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:23

L24	366	((surface near (clean\$3 ablat\$3)) same (substrate wafer semiconduct\$3)) and ((laser near (clean\$3 ablat\$3)) same (substrate wafer semiconduct\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:23
L25	934	23 and ((film layer) near (inspect\$3 measur\$4 monitor\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:23
L26	20	24 and ((film layer) near (inspect\$3 measur\$4 monitor\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 22:24